

Berlin, Germany - July 2017

| Name                 | Employer                              | Affiliation                            | Mon | Tue | Wed | Thu | Credit |
|----------------------|---------------------------------------|--|-----|-----|-----|-----|--------|
| Abramson, David      | Texas Instruments Incorporated        | Texas Instruments Incorporated         | 1   |     | 1   | 1   | 3      |
| Agnes, Andrea        | STMicroelectronics                    | STMicroelectronics                     | 1   | 1   | 1   | 1   | 4      |
| Akasaki, Shogo       | DENSO                                 | DENSO                                  | 1   | 1   | 1   | 1   | 4      |
| Angha, Ali           | Spirent Communications                | Spirent Communications                 | 1   | 1   | 1   | 1   | 4      |
| Anslow, Peter        | Ciena Corporation                     | Ciena Corporation                      | 1   | 1   | 1   | 1   | 4      |
| Bains, Amrik         | Cisco Systems, Inc.                   | Cisco Systems, Inc.                    | 1   | 1   | 1   | 1   | 4      |
| Bergner, Bert        | TE Connectivity Germany GmbH          | TE Connectivity                        | 1   | 1   | 1   | 1   | 4      |
| Beruto, Piergiorgio  | Canovatech S.r.l.                     | Canova Tech Srl                        | 1   | 1   | 1   | 1   | 4      |
| Bhatt, Vipul         | Finisar Corporation                   | Inphi Corporation                      | 1   | 1   | 1   | 1   | 4      |
| Bonk, Rene           | Nokia                                 | Nokia                                  |     | 1   | 1   |     | 2      |
| Booth, Brad          | Microsoft Corporation                 | Microsoft Corporation                  | 1   | 1   | 1   |     | 3      |
| Brandt, David        | Rockwell Automation                   | Rockwell Automation                    | 1   | 1   | 1   |     | 3      |
| Braun, Ralf-Peter    | Deutsche Telekom AG                   | Deutsche Telekom AG                    | 1   | 1   | 1   | 1   | 4      |
| Brillhart, Theodore  | Fluke Corporation                     | Fluke Corporation                      |     | 1   | 1   | 1   | 3      |
| Brown, Matthew       | Applied Micro (AMCC)                  | Applied Micro (AMCC)                   | 1   | 1   | 1   | 1   | 4      |
| Brunner, Stefan      | Continental Automotive GmbH           | Continental Automotive Systems AG      |     | 1   |     |     | 1      |
| Buntz, Stefan        | Daimler AG                            | Daimler AG                             |     | 1   | 1   | 1   | 3      |
| Butter, Adrian       | GLOBALFOUNDRIES                       | GLOBALFOUNDRIES                        | 1   | 1   | 1   | 1   | 4      |
| Canchi, Radhakrishna | Kyocera International Inc.            | Kyocera Communications Inc.            | 1   |     |     |     | 1      |
| Carlson, Steven      | High-Speed Design Inc.                | Robert Bosch GmbH                      | 1   | 1   | 1   | 1   | 4      |
| Chabot, Craig        | University of New Hampshire InterOper | University of New Hampshire InterOpera | 1   | 1   | 1   |     | 3      |
| Chadha, Mandeep      | Microsemi Corporation                 | Microsemi Corporation                  |     | 1   | 1   | 1   | 3      |
| Chang, Xin           | Huawei Technologies Co. Ltd           | Huawei Technologies Co. Ltd            |     | 1   | 1   | 1   | 3      |
| Chen, Chan           | Applied Optoelectronics, Inc.         | Applied Optoelectronics, Inc.          | 1   | 1   | 1   | 1   | 4      |
| Cheng, Weiying       | Coriant                               | Coriant                                |     |     |     | 1   | 1      |
| Choudhury, Golam     | OFS                                   | OFS                                    | 1   | 1   | 1   | 1   | 4      |
| Chuang, Keng Hua     | Hewlett Packard Enterprise            | Hewlett-Packard Development Company    | 1   | 1   | 1   | 1   | 4      |
| Chwalek, Sascha      |                                       | Viavi Solutions                        |     | 1   | 1   |     | 2      |
| Dai, Eugene          | Cox Communications Inc.               | Cox Communications Inc.                |     | 1   | 1   |     | 2      |
| Dai, Lizhi           |                                       | MediaTek Inc.                          | 1   | 1   |     |     | 2      |
| Dalmia, Kamal        | Aquantia                              | Aquantia                               |     | 1   | 1   | 1   | 3      |
| D'Ambrosia, John     | Futurewei Technologies                | Futurewei (Subsidiary of Huawei)       | 1   | 1   |     | 1   | 3      |

Berlin, Germany - July 2017

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| Darshan, Yair         | Microsemi Corporation                   | Microsemi Corporation                  | 1   | 1   | 1   |     | 3      |
| Dawe, Piers J G       | Mellanox Technologies                   | Mellanox Technologies                  |     | 1   | 1   | 1   | 3      |
| Dawson, Fred          | Chemours Canada Company                 | Chemours Canada Company                |     |     | 1   | 1   | 2      |
| Diminico, Christopher | M C Communications, LLC                 | Panduit Corp.                          | 1   | 1   | 1   |     | 3      |
| Donahue, Curtis       | University of New Hampshire InterOperat | UNH-IOL                                | 1   | 1   | 1   |     | 3      |
| Donnay, Elizabeth     | Cisco Systems, Inc.                     | Cisco Systems, Inc.                    | 1   | 1   | 1   | 1   | 4      |
| Dudek, Michael        | Cavium                                  | Cavium                                 | 1   | 1   | 1   | 1   | 4      |
| Effenberger, Frank    | Huawei Technologies Co. Ltd             | Huawei Technologies Co. Ltd            | 1   | 1   | 1   | 1   | 4      |
| Eitel, Cornelia       | Hirschmann Automation and Control, Inc  | Hirschmann Automation and Control, Inc | 1   | 1   | 1   | 1   | 4      |
| Estes, David          | Spirent Communications                  | Spirent Communications                 | 1   | 1   | 1   | 1   | 4      |
| farjad, ramin         | Aquantia                                | Aquantia                               |     | 1   | 1   | 1   | 3      |
| Fawcett, Darren       | ARRIS Group                             | ARRIS Group                            |     | 1   |     |     | 1      |
| Fife, James           | eTopus Technology, Inc.                 | eTopus Technology, Inc.                | 1   | 1   | 1   | 1   | 4      |
| Filip, Jan            | Maxim Integrated Products               | Maxim Integrated Products              |     | 1   | 1   |     | 2      |
| Flatman, Alan         | LAN Technologies Corporation, Inc.      | LAN Technologies Corporation, Inc.     | 1   | 1   | 1   | 1   | 4      |
| Franchuk, Brian       | Emerson Automation Solutions            | Emerson Automation Solutions           | 1   | 1   | 1   | 1   | 4      |
| Fritsche, Matthias    | HARTING Technologie Gruppe              | HARTING Electronics GmbH               | 1   | 1   | 1   | 1   | 4      |
| Frosch, Richard       | Phihong USA Inc,                        | Phihong USA Inc,                       | 1   | 1   | 1   |     | 3      |
| Gauthier, Claude      | OmniPhy                                 | OmniPhy                                | 1   | 1   | 1   |     | 3      |
| Geng, Dan             | ZTE Corporation                         | ZTE                                    |     |     | 1   |     | 1      |
| Ghiasi, Ali           | Ghiasi Quantum LLC                      | Ghiasi Quantum LLC, Huawei LTD         | 1   | 1   | 1   | 1   | 4      |
| Gorshe, Steven Scott  | Microsemi Corporation                   | Microsemi Corporation                  | 1   | 1   | 1   | 1   | 4      |
| Gottron, Jens         | Siemens AG                              | Siemens AG                             |     | 1   | 1   | 1   | 3      |
| Graber, Steffen       | Pepperl+Fuchs GmbH                      | Pepperl+Fuchs GmbH                     | 1   | 1   | 1   | 1   | 4      |
| Grabherr, Martin      |   | Priolas GmbH                           | 1   | 1   | 1   | 1   | 4      |
| Grau, Olaf            | Robert Bosch GmbH                       | Robert Bosch GmbH                      | 1   | 1   | 1   | 1   | 4      |
| Grillaert, Joost      | Nexans                                  | Nexans                                 |     | 1   | 1   | 1   | 3      |
| Grow, Robert          | RMG Consulting                          | RMG Consulting                         | 1   | 1   | 1   | 1   | 4      |
| GUO, YONG             | ZTE Corporation                         | ZTE Corporation                        | 1   | 1   | 1   |     | 3      |
| Gustlin, Mark         | Xilinx                                  | Xilinx                                 | 1   | 1   | 1   | 1   | 4      |
| Han, Ruibo            | China Mobile Communications Corporati   | China Mobile Communications Corporati  | 1   | 1   | 1   | 1   | 4      |
| Harstead, Ed          | Nokia                                   | Nokia                                  |     | 1   | 1   |     | 2      |

Berlin, Germany - July 2017

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|----------------------|---|---------------------------------------|-----|-----|-----|-----|--------|
| Hashimoto, Tomohiro  | socionext                               | socionext                             | 1   | 1   | 1   | 1   | 4      |
| Hayakawa, Akinori    | FUJITSU LABORATORIES LIMITED            | FUJITSU LABORATORIES LIMITED          | 1   | 1   | 1   | 1   | 4      |
| Hayashi, Takehiro    | HAT Lab., Inc.                          | HAT Lab., Inc.                        | 1   | 1   | 1   | 1   | 4      |
| Healey, Adam         | Broadcom Ltd.                           | Broadcom Ltd.                         | 1   | 1   | 1   | 1   | 4      |
| Hegde, Rajmohan      | Broadcom Corporation                    | Broadcom Corporation                  | 1   | 1   | 1   |     | 3      |
| Hess, David          | CORD DATA                               | CORD DATA                             | 1   | 1   | 1   | 1   | 4      |
| Hidaka, Yasuo        | Fujitsu Laboratories of America, Inc.   | Fujitsu Laboratories of America, Inc. | 1   | 1   | 1   | 1   | 4      |
| Hirth, Ryan          | Broadcom Corporation                    | Broadcom Corporation                  |     | 1   | 1   | 1   | 3      |
| Hogenmueller, Thomas | Robert Bosch GmbH                       | Robert Bosch GmbH                     | 1   | 1   | 1   |     | 3      |
| Hoglund, David       | Johnson Controls Inc                    | Johnson Controls Inc                  | 1   | 1   | 1   | 1   | 4      |
| Hormmeyer, Bernd     | Phoenix Contact                         | Phoenix Contact                       | 1   | 1   | 1   | 1   | 4      |
| HUANG, Xi            | Huawei Technologies Co. Ltd             | Huawei Technologies Co. Ltd           | 1   | 1   | 1   | 1   | 4      |
| HYAKUTAKE, YASUHIRO  | Adamant Co., Ltd.                       | Adamant Co., Ltd.                     | 1   | 1   | 1   | 1   | 4      |
| Ilyadis, Nicholas    | Marvell Semiconductor, Inc.             | Marvell Semiconductor, Inc.           |     | 1   |     |     | 1      |
| Ingham, Jonathan     | Foxconn Interconnect Technology         | Foxconn Interconnect Technology       |     | 1   | 1   | 1   | 3      |
| ISHIBE, KAZUHIKO     | Anritsu Company                         | Anritsu Company                       | 1   | 1   | 1   | 1   | 4      |
| Islinger, Tobias     | DENSO AUTOMOTIVE Deutschland            | DENSO AUTOMOTIVE GERMANY              | 1   |     |     |     | 1      |
| Isono, Hideki        | FUJITSU                                 | Fujitsu Optical Components Limited    | 1   | 1   | 1   | 1   | 4      |
| Issenhuth, Tom       | Issenhuth Consulting, LLC               | Huawei Technologies Co. Ltd           | 1   | 1   | 1   | 1   | 4      |
| Jackson, Kenneth     | Sumitomo Electric Device Innovations, U | Sumitomo Electric Industries, LTD     | 1   | 1   | 1   | 1   | 4      |
| Jimenez, Andrew      | Anixter Inc.                            | Anixter Inc.                          |     | 1   | 1   | 1   | 3      |
| Johnson, John        | Broadcom Limited                        | Broadcom Limited                      | 1   | 1   | 1   | 1   | 4      |
| Jones, Chad          | Cisco Systems, Inc.                     | Cisco Systems, Inc.                   | 1   |     | 1   | 1   | 3      |
| Jones, Peter         | Cisco Systems, Inc.                     | Cisco Systems, Inc.                   | 1   | 1   | 1   | 1   | 4      |
| Kagami, Manabu       | Toyota Central R&D Labs                 | Toyota Central R&D Labs               | 1   | 1   | 1   | 1   | 4      |
| Kang, Vincent        | GUC                                     | GUC                                   | 1   | 1   | 1   | 1   | 4      |
| Kareti, Upen         | Cisco Systems, Inc.                     | Cisco Systems, Inc.                   | 1   | 1   | 1   | 1   | 4      |
| Kawatsu, Yasuaki     | APRESIA Systems                         | Hitachi Metals, Ltd.                  | 1   | 1   | 1   | 1   | 4      |
| Kiefer, Adrian       |   | Fachhochschule Nordwestschweiz        | 1   | 1   |     |     | 2      |
| Kim, Yongbum         | Broadcom LTD                            | Broadcom Corporation                  |     | 1   | 1   | 1   | 3      |
| Kimber, Eric         | Semtech Ltd                             | Semtech Ltd                           | 1   | 1   | 1   | 1   | 4      |
| King, Jonathan       | Finisar Corporation                     | Finisar Corporation                   |     | 1   | 1   |     | 2      |

Berlin, Germany - July 2017

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|--------------------|---|---|-----|-----|-----|-----|--------|
| Klaus, Andrew      | Marvell Semiconductor, Inc.               | JASPAR; Marvell Semiconductor, Inc.       | 1   | 1   | 1   | 1   | 4      |
| Knittle, Curtis    | Cable Television Laboratories Inc. (Cable | Cable Television Laboratories Inc. (Cable | 1   | 1   |     | 1   | 3      |
| Kobayashi, Shigeru | Tyco Electronics Japan                    | TE Connectivity                           | 1   | 1   | 1   | 1   | 4      |
| Koehler, Daniel    | MorethanIP                                | MorethanIP                                | 1   | 1   | 1   |     | 3      |
| Krieger, Olaf      | Volkswagen AG                             | Volkswagen AG                             | 1   | 1   | 1   |     | 3      |
| Kropp, Joerg       | VI Systems GmbH                           | VI Systems GmbH                           | 1   | 1   | 1   |     | 3      |
| Lackner, Hans      | QoSCom GmbH                               | QoSCom - Quality in Communications - G    | 1   | 1   | 1   | 1   | 4      |
| Lapak, Jeffrey     | University of New Hampshire InterOpera    | University of New Hampshire InterOpera    | 1   | 1   | 1   | 1   | 4      |
| Laubach, Mark      | Broadcom Limited                          | Broadcom Corporation                      | 1   | 1   | 1   | 1   | 4      |
| Law, David         | Hewlett Packard Enterprise                | Hewlett Packard Enterprise                | 1   | 1   | 1   | 1   | 4      |
| Le Cheminant, Greg | Keysight Technologies                     | Keysight Technologies                     |     | 1   | 1   |     | 2      |
| Lee, Han Hyub      | ETRI                                      | ETRI                                      | 1   | 1   | 1   |     | 3      |
| Lee, June Hee      | SAMSUNG ELECTRONICS                       | SAMSUNG ELECTRONICS                       | 1   | 1   | 1   | 1   | 4      |
| Leizerovich, Hanan | Multiphy                                  | Multiphy                                  | 1   | 1   | 1   |     | 3      |
| Lewis, David       | Lumentum Inc.                             | Lumentum Inc.                             | 1   | 1   | 1   | 1   | 4      |
| Lewis, Jon         | Dell EMC                                  | Dell                                      | 1   | 1   | 1   | 1   | 4      |
| Li, Mike-Peng      | Intel Corporation                         | Intel Corporation                         | 1   | 1   | 1   | 1   | 4      |
| Liao, Zhenxing     | HUAWEI                                    | Huawei Technologies Co. Ltd               | 1   | 1   | 1   |     | 3      |
| Lim, Jane          | Cisco Systems, Inc.                       | Cisco Systems, Inc.                       | 1   | 1   | 1   | 1   | 4      |
| Lin, Alex          | MediaTek                                  | MediaTek Inc.                             | 1   | 1   |     | 1   | 3      |
| Lingle, Robert     | OFS                                       | OFS                                       | 1   | 1   | 1   | 1   | 4      |
| liu, dekun         | Huawei Technologies Co., Ltd              | Huawei Technologies Co. Ltd               | 1   | 1   | 1   |     | 3      |
| Lukacs, Miklos     | Silicon Laboratories                      | Silicon Laboratories                      |     | 1   | 1   | 1   | 3      |
| Lusted, Kent       | Intel Corporation                         | Intel Corporation                         | 1   | 1   | 1   |     | 3      |
| Madgar, Zahy       | Valens Semiconductor                      | Valens Semiconductor                      |     | 1   | 1   |     | 2      |
| Maguire, Valerie   | The Siemon Company                        | The Siemon Company                        | 1   | 1   | 1   | 1   | 4      |
| Maki, Jeffery      | Juniper Networks, Inc.                    | Juniper Networks, Inc.                    | 1   | 1   | 1   | 1   | 4      |
| Marris, Arthur     | Cadence Design Systems, Inc.              | Cadence Design Systems, Inc.              | 1   | 1   | 1   | 1   | 4      |
| MASUDA, TAKEO      | OITDA                                     | OITDA                                     | 1   |     | 1   | 1   | 3      |
| Matheus, Kirsten   | BMW Group                                 | BMW Group                                 | 1   | 1   | 1   | 1   | 4      |
| McCarthy, Mick     | Analog Devices Inc.                       | Analog Devices Inc.                       | 1   | 1   | 1   | 1   | 4      |
| McClellan, Brett   | Marvell Semiconductor, Inc.               | Marvell Semiconductor, Inc.               | 1   | 1   | 1   | 1   | 4      |

Berlin, Germany - July 2017

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| McSorley, Gregory   | Amphenol Corporation         | Amphenol Corporation         | 1   |     | 1   | 1   | 3      |
| Meachen, Jacob      | Semtech EMEA                 | Semtech Ltd                  |     | 1   | 1   | 1   | 3      |
| Medina, Marcel      | Spirent Communications       | Spirent Communications       |     | 1   | 1   | 1   | 3      |
| Mellitz, Richard    | Samtec, Inc.                 | Samtec, Inc.                 | 1   | 1   | 1   | 1   | 4      |
| Montemezzo, Nicola  |                              | Canova Tech                  |     | 1   | 1   | 1   | 3      |
| Mueller, Harald     | Endress + Hauser             | Endress + Hauser             | 1   |     |     |     | 1      |
| Mueller, Thomas     | Rosenberger                  | Rosenberger                  | 1   | 1   | 1   |     | 3      |
| Murthy, Ram         | Spirent Communications       | Spirent Communications       |     |     | 1   |     | 1      |
| Muth, Karlheinz     | Rockley Photonics            | Rockley Photonics            | 1   | 1   | 1   | 1   | 4      |
| Muyshondt, Henry    | Microchip Technology, Inc.   | Microchip Technology, Inc.   | 1   | 1   | 1   | 1   | 4      |
| Nakamoto, Edward    | Spirent Communications       | Spirent Communications       | 1   | 1   | 1   | 1   | 4      |
| Nicholl, Gary       | Cisco Systems, Inc.          | Cisco Systems, Inc.          |     | 1   |     | 1   | 2      |
| Nie, Shiwei         | Huawei Technologies Co., Ltd | Huawei Technologies Co., Ltd | 1   | 1   | 1   |     | 3      |
| Nordin, Ronald      | Panduit Corp.                | Panduit Corp.                | 1   | 1   | 1   |     | 3      |
| Nowell, Mark        | Cisco Systems, Inc.          | Cisco Systems, Inc.          | 1   | 1   | 1   | 1   | 4      |
| O Cuanachain, Oisin | Analog Devices Inc.          | Analog Devices Inc.          |     | 1   |     |     | 1      |
| Ofelt, David        | Juniper Networks, Inc.       | Juniper Networks, Inc.       | 1   | 1   |     | 1   | 3      |
| Palkert, Thomas     | EIC                          | Molex-MoSys                  | 1   | 1   | 1   |     | 3      |
| Pandey, Sujan       | NXP Semiconductors           | NXP Semiconductors           | 1   | 1   | 1   | 1   | 4      |
| PARK, MOONSOO       | OE solutions                 | OE solutions                 |     | 1   | 1   |     | 2      |
| Peker, Arkadiy      | Microsemi Corporation        | Microsemi Corporation        | 1   | 1   | 1   | 1   | 4      |
| Petrie, Richard     | Microchip Technology, Inc.   | Microchip Technology, Inc.   | 1   | 1   | 1   |     | 3      |
| Pham, Phong         | US Conec, Ltd.               | US Conec, Ltd.               | 1   | 1   | 1   |     | 3      |
| Poehmerer, Rainer   | LEONI Kabel GmbH             | LEONI                        |     | 1   | 1   |     | 2      |
| Powell, William     | Nokia                        | Nokia                        |     | 1   | 1   | 1   | 3      |
| Pozzebon, Dino      | Microsemi Corporation        | Microsemi Corporation        | 1   | 1   | 1   | 1   | 4      |
| RAN, ADEE           | Intel Corporation            | Intel Corporation            | 1   | 1   | 1   | 1   | 4      |
| Rashidi, Habib      |                              | Pulse Electronics            |     | 1   |     |     | 1      |
| Rechtman, Zvi       | Mellanox Technologies        | Mellanox Technologies        | 1   | 1   | 1   | 1   | 4      |
| Regev, Alon         | Ixia                         | Ixia                         | 1   | 1   | 1   | 1   | 4      |
| Rerein, Duane       | Futurewei Technologies       | Huawei Technologies Co. Ltd  | 1   | 1   | 1   | 1   | 4      |
| Roszbach, Martin    | Nexans Cabling Solutions     | Nexans SA                    |     |     | 1   |     | 1      |

Berlin, Germany - July 2017

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| Rotolo, Salvatore   | STMicroelectronics                   | STMicroelectronics                    | 1   | 1   | 1   | 1   | 4      |
| Rysin, Alexander    |                                      | Mellanox Technologies                 | 1   | 1   | 1   |     | 3      |
| Schicketanz, Dieter | CONSULTANT                           | CONSULTANT; Reutlingen University     | 1   | 1   | 1   | 1   | 4      |
| Schmidt, Robert     | DENSO Europe                         | DENSO AUTOMOTIVE Deutschland          | 1   |     |     |     | 1      |
| Schwenk, Martin     |                                      | FUJITSU                               | 1   | 1   | 1   | 1   | 4      |
| Sedarat, Hossein    | Aquantia                             | Aquantia                              |     |     | 1   |     | 1      |
| Shariff, Masood     | CommScope, Inc.                      | CommScope, Inc.                       | 1   | 1   | 1   | 1   | 4      |
| SHIH-CHIN, YANG     | Applied Optoelectronics, Inc         | 3e Technologies International, Inc.   | 1   |     |     | 1   | 2      |
| shirani, ramin      | Aquantia                             | Aquantia                              | 1   | 1   | 1   | 1   | 4      |
| Shirao, Mizuki      | Mitsubishi Electric Corporation      | Mitsubishi Electric Corporation       | 1   | 1   | 1   | 1   | 4      |
| Shrikhande, Kapil   | Innovium Inc.                        | Innovium                              |     | 1   | 1   | 1   | 3      |
| Smith, Daniel       | Seagate Technology LLC               | Seagate Technology LLC                | 1   | 1   | 1   | 1   | 4      |
| Sommers, Scott      | Molex Incorporated                   | Molex Incorporated                    | 1   | 1   | 1   |     | 3      |
| Sone, Yoshiaki      | NTT                                  | Nippon Telegraph and Telephone Corpor | 1   | 1   | 1   | 1   | 4      |
| Sprague, Edward     | Infinera Corporation                 | Infinera Corporation                  |     | 1   | 1   | 1   | 3      |
| Stassar, Peter      | Huawei Technologies Co. Ltd          | Huawei Technologies Co. Ltd           | 1   | 1   | 1   | 1   | 4      |
| Stewart, Heath      | Analog Devices Inc.                  | Linear Technology                     | 1   | 1   | 1   | 1   | 4      |
| Stover, David       | Analog Devices Inc.                  | Linear Technology                     | 1   | 1   | 1   | 1   | 4      |
| Sun, Liyang         | Huawei Technologies Co. Ltd          | Huawei Technologies Co. Ltd           | 1   | 1   | 1   | 1   | 4      |
| Suzuki, Ken-Ichi    | Nippon Telegraph and Telephone Corpo | NTT                                   | 1   | 1   | 1   | 1   | 4      |
| Suzuki, Naoki       | Mitsubishi Electric Corporation      | Mitsubishi Electric Corporation       | 1   | 1   | 1   |     | 3      |
| Swanson, Steven     | Corning Incorporated                 | Corning Incorporated                  | 1   | 1   |     | 1   | 3      |
| Szczepanek, Andre   | HSZ Consulting Ltd                   | HSZ Consulting Ltd                    | 1   | 1   | 1   |     | 3      |
| Tailor, Bharat      | Semtech Canada Corporation           | Semtech Canada Corporation            |     | 1   | 1   | 1   | 3      |
| TAKAHARA, TOMOO     | FUJITSU LABORATORIES LIMITED         | FUJITSU LABORATORIES LIMITED          | 1   | 1   | 1   | 1   | 4      |
| Takai, Atsushi      | Oclaro                               | Huawei Technologies Japan K.K.        | 1   | 1   | 1   | 1   | 4      |
| Takai, Yosuke       |                                      | Yamaichi Electronics                  | 1   | 1   | 1   | 1   | 4      |
| Tamura, Kohichi     | Oclaro Japan Inc.                    | Oclaro Japan Inc.                     | 1   | 1   | 1   |     | 3      |
| Tan, Alexander      | Marvell Semiconductor, Inc.          | NXP Semiconductors                    | 1   | 1   | 1   | 1   | 4      |
| Tan, Kan            | Tektronix, Inc.                      | Tektronix, Inc.                       | 1   | 1   | 1   | 1   | 4      |
| Thompson, Geoffrey  | GraCaSI S.A.                         | INDEPENDENT                           | 1   | 1   | 1   | 1   | 4      |
| Tooyserkani, Pirooz | Cisco Systems, Inc.                  | Cisco Systems, Inc.                   | 1   | 1   | 1   | 1   | 4      |

Berlin, Germany - July 2017

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| Tost, Johann          |                                       | Rohde & Schwarz                       |     | 1   | 1   |     | 2      |
| Tracy, Nathan         | TE Connectivity                       | TE Connectivity                       | 1   | 1   | 1   | 1   | 4      |
| Traverso, Matthew     | Cisco Systems, Inc.                   | Cisco Systems, Inc.                   | 1   | 1   | 1   | 1   | 4      |
| Trowbridge, Stephen   | Nokia                                 | Nokia                                 | 1   | 1   | 1   | 1   | 4      |
| TSENG, TA CHIN        | Realtek Semiconductor Corp.           | Realtek Semiconductor Corp.           | 1   | 1   | 1   |     | 3      |
| Ulrichs, Ed           | Source Photonics                      | Source Photonics                      | 1   | 1   | 1   | 1   | 4      |
| Umeda, Daisuke        | Sumitomo Electric Industries, LTD     | Sumitomo Electric Industries, LTD     |     | 1   | 1   | 1   | 3      |
| Umnov, Alexander      | Corning Incorporated                  | Corning Incorporated                  |     | 1   | 1   | 1   | 3      |
| Vaden, Sterling       | Vaden Enterprises                     | Vaden Enterprises                     | 1   | 1   | 1   | 1   | 4      |
| van der Horst, Allard | Semtech Ltd                           | Semtech Ltd                           |     | 1   | 1   |     | 2      |
| Vanderlaan, Paul      | Berk-Tek LLC                          | Berk-Tek LLC                          | 1   | 1   | 1   | 1   | 4      |
| Walker, Dylan         | Cisco Systems, Inc.                   | Cisco Systems, Inc.                   | 1   |     | 1   | 1   | 3      |
| Walter, Edward        | AT&T                                  | AT&T                                  |     | 1   | 1   | 1   | 3      |
| wang, haifei          | Huawei Technologies Co. Ltd           | Huawei Technologies Co., Ltd          | 1   | 1   | 1   | 1   | 4      |
| Wang, Xinyuan         | Huawei Technologies Co. Ltd           | Huawei Technologies Co. Ltd           | 1   | 1   | 1   | 1   | 4      |
| Weber, Markus         | socionext                             | Acacia Communications                 |     | 1   | 1   | 1   | 3      |
| Wechsler, Christoph   | Audi AG                               | Audi AG                               | 1   | 1   | 1   | 1   | 4      |
| Wendt, Matthias       | Philips Lighting                      | Philips Lighting                      | 1   | 1   | 1   | 1   | 4      |
| white, martin         | Cavium                                | Cavium                                | 1   | 1   | 1   | 1   | 4      |
| Wienckowski, Natalie  | General Motors Company                | General Motors Company                | 1   | 1   | 1   | 1   | 4      |
| Williams, Tom         | Acacia Communications                 | Acacia Communications                 | 1   | 1   | 1   | 1   | 4      |
| Winkel, Ludwig        | Siemens AG                            | Siemens AG                            |     | 1   | 1   | 1   | 3      |
| Withey, James         | Fluke Corporation                     | Fluke Corporation                     | 1   | 1   | 1   | 1   | 4      |
| Wucher, Markus        | Endress + Hauser Flowtec AG           | Endress + Hauser                      | 1   | 1   | 1   | 1   | 4      |
| Xu, Dayin             | Rockwell Automation                   | Rockwell Automation                   | 1   | 1   | 1   | 1   | 4      |
| Xu, Yu                | Huawei Technologies Co. Ltd           | Huawei Technologies Co. Ltd           | 1   | 1   | 1   | 1   | 4      |
| Yamamoto, Shuto       | Nippon Telegraph and Telephone Corpor | Nippon Telegraph and Telephone Corpor |     | 1   | 1   | 1   | 3      |
| Yasueda, Jim          | Teledyne Lecroy                       | Teledyne Lecroy                       |     | 1   | 1   |     | 2      |
| Yin, Jinrong          | Huawei                                | Huawei Technologies Co., Ltd          | 1   | 1   | 1   |     | 3      |
| Yseboodt, Lennart     | Philips Lighting                      | Philips Electronics                   | 1   |     | 1   |     | 2      |
| Yuan, Liquan          | ZTE Corporation                       | ZTE Corporation                       | 1   | 1   | 1   |     | 3      |
| Zerna, Conrad         | Fraunhofer IIS                        | Fraunhofer IIS                        | 1   | 1   | 1   |     | 3      |

Berlin, Germany - July 2017

| Name              | Employer                          | Affiliation                          | Mon | Tue | Wed | Thu | Credit |
|-------------------|-----------------------------------|--------------------------------------|-----|-----|-----|-----|--------|
| Zhao, Qing        | HUAWEI                            | HUAWEI                               | 1   | 1   | 1   | 1   | 4      |
| Zhuang, Yan       | Huawei Technologies Co. Ltd       | Huawei Technologies Co. Ltd          | 1   | 1   | 1   | 1   | 4      |
| Zielinski, Martin | Emerson Electric Co.              | Emerson Process Management           | 1   | 1   | 1   | 1   | 4      |
| Zimmerman, George | CME Consulting                    | ADI, APL Group, Aquantia, BMW, Comms | 1   | 1   |     | 1   | 3      |
| Zinner, Helge     | Continental Automotive Systems AG | Continental Automotive Systems AG    | 1   | 1   | 1   | 1   | 4      |
| Zivny, Pavel      | Tektronix, Inc.                   | Tektronix, Inc.                      | 1   | 1   | 1   | 1   | 4      |
| Zweck, Harald     | Infineon Technologies AG          | Infineon Technologies AG             |     | 1   | 1   |     | 2      |